

IGBT

SGP10N60RUFD

Short Circuit Rated IGBT

General Description

Fairchild's Insulated Gate Bipolar Transistor(IGBT) RUFD series provides low conduction and switching losses as well as short circuit ruggedness. RUFD series is designed for the applications such as motor control, UPS and general inverters where short-circuit ruggedness is required.

Features

- Short Circuit rated 10us @ $T_C = 100$ °C, $V_{GE} = 15$ V
- High Speed Switching
- Low Saturation Voltage : $V_{CE(sat)} = 2.2 \text{ V} @ I_C = 10 \text{A}$
- High Input Impedance
- CO-PAK, IGBT with FRD : $t_{rr} = 42$ ns (typ.)

Application

AC & DC Motor controls, General Purpose Inverters, Robotics, Servo Controls





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		SGP10N60RUFD	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
	Collector Current	@ T _C = 25°C	16	А
I _C	Collector Current	@ T _C = 100°C	10	Α
I _{CM (1)}	Pulsed Collector Current		30	А
I _F	Diode Continuous Forward Current	@ T _C = 100°C	12	Α
I _{FM}	Diode Maximum Forward Current		92	Α
T _{SC}	Short Circuit Withstand Time	@ T _C = 100°C	10	us
P _D	Maximum Power Dissipation	@ T _C = 25°C	75	W
	Maximum Power Dissipation	@ T _C = 100°C	30	W
TJ	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

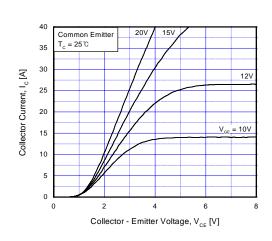
Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
R _{θJC} (IGBT)	Thermal Resistance, Junction-to-Case		1.6	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV _{CES}	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
ΔB _{VCES} / ΔT _J	Temperature Coeff. of Breakdown Voltage	V _{GE} = 0V, I _C = 1mA		0.6		V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Chai	racteristics					
V _{GE(th)}	G-E Threshold Voltage	$I_C = 10mA$, $V_{CE} = V_{GE}$	5.0	6.0	8.5	V
	Collector to Emitter	$I_C = 10A$, $V_{GF} = 15V$		2.2	2.8	V
$V_{CE(sat)}$	Saturation Voltage	$I_C = 16A$, $V_{GE} = 15V$		2.5		V
Dynami	Characteristics	32				
C _{ies}	C Characteristics Input Capacitance			660		pF
C _{oes}	Output Capacitance	$V_{CE} = 30V$, $V_{GE} = 0V$,		115		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		25		pF
t _{d(on)}	ng Characteristics Turn-On Delay Time			15		ns
t _r	Rise Time			30		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 10\text{A},$		36	50	ns
<u>·α(οπ)</u> t _f	Fall Time	$R_G = 20\Omega$, $V_{GE} = 15V$,		158	200	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C		141		uJ
E _{off}	Turn-Off Switching Loss			215		uJ
E _{ts}	Total Switching Loss			356	500	uJ
t _{d(on)}	Turn-On Delay Time			16		ns
t _r	Rise Time	_		33		ns
t _{d(off)}	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 10\text{A},$		42	60	ns
t _f	Fall Time	$R_G = 20\Omega$, $V_{GE} = 15V$,		242	350	ns
E _{on}	Turn- On Switching Loss	Inductive Load, T _C = 125°C		161		uJ
E _{off}	Turn- Off Switching Loss			452		uJ
E _{ts}	Total Switching Loss			613	860	uJ
T _{sc}	Short Circuit Withstand Time	V _{CC} = 300 V, V _{GE} = 15V @ T _C = 100°C	10			us
Q _a	Total Gate Charge			30	45	nC
Q _{ge}	Gate-Emitter Charge	$V_{CE} = 300 \text{ V, } I_{C} = 10 \text{A,}$ $V_{GE} = 15 \text{V}$		5	10	nC
Q_{gc}	Gate-Collector Charge	VGE = 13V		8	16	nC

Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
\/	Diode Forward Voltage	L = 12A	$T_C = 25^{\circ}C$		1.4	1.7	1/
V_{FM}	Diode Forward Voltage	I _F = 12A	T _C = 100°C		1.3		V
+	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$		42	60	nc
'rr	t _{rr} Diode Reverse Recovery Time		T _C = 100°C		60		ns
	Diode Peak Reverse Recovery	I _F = 12A,	$T_C = 25^{\circ}C$		3.5	6.0	Α
¹rr	Current	$di/dt = 200A/\mu s$	T _C = 100°C		5.6		A
Q_{rr}	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		80	180	nC
			T _C = 100°C	1	220		IIC



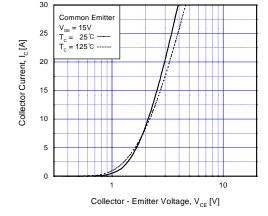
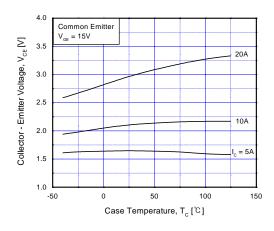


Fig 1. Typical Output Characteristics

Fig 2. Typical Saturation Voltage Characteristics



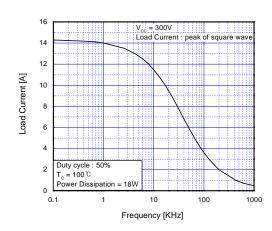
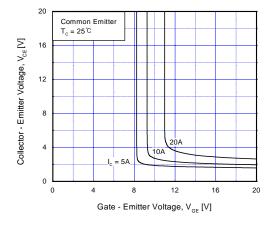


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

Fig 4. Load Current vs. Frequency



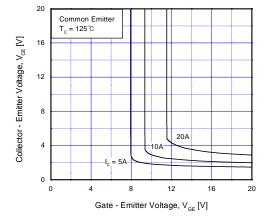
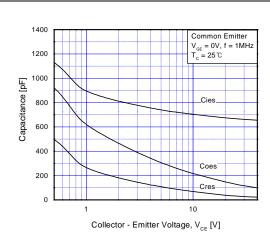


Fig 5. Saturation Voltage vs. V_{GE}

Fig 6. Saturation Voltage vs. $V_{\rm GE}$

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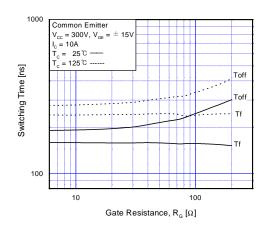


 $V_{cc} = 300V, V_{GE} = \pm 15V$ $I_{c} = 10A$ $T_{c} = 25^{\circ}C$ T_c = 125 °C -----Switching Time [ns] 10 10 Gate Resistance, $R_{_{G}}[\Omega]$

Common Emitter

Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs. **Gate Resistance**



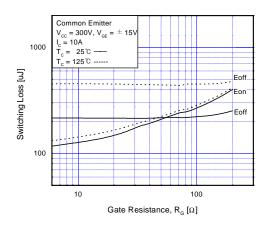
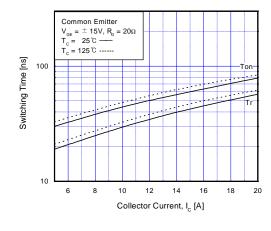


Fig 9. Turn-Off Characteristics vs. **Gate Resistance**

Fig 10. Switching Loss vs. Gate Resistance



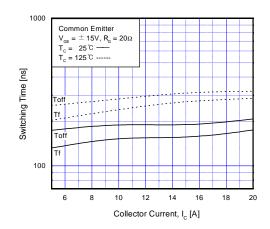
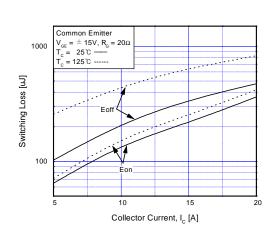


Fig 11. Turn-On Characteristics vs. **Collector Current**

Fig 12. Turn-Off Characteristics vs. **Collector Current**



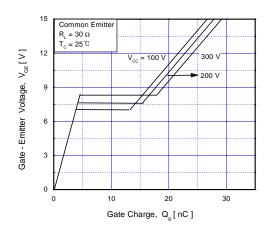
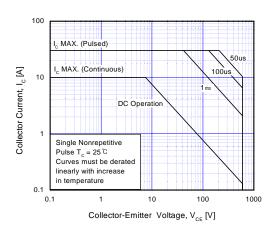


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



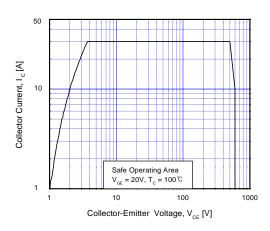


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

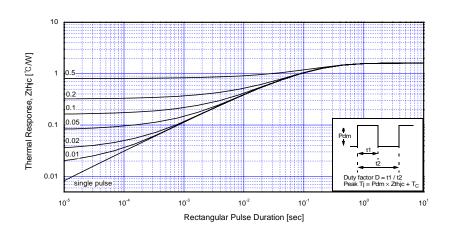
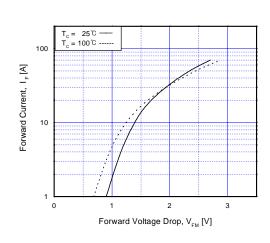


Fig 17. Transient Thermal Impedance of IGBT

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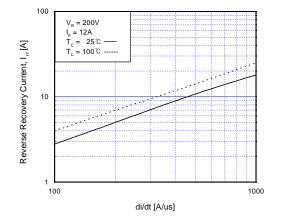
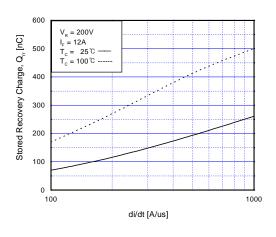


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current



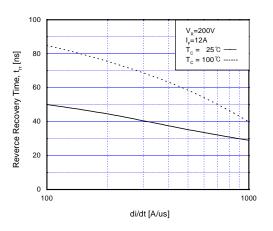


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time

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